

Attorney Docket No. 44085-159

COMBINED DECLARATION/POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor(s), I(we) hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled PRESS MOLDING METHOD FOR GLASS AND MANUFACTURING METHOD FOR GLASS SUBSTRATE USING THIS METHOD, the specification of which

(check one) is attached hereto.

X was filed on Aug. 6, 2002 as
United States Application No. _____

— PCT International Patent Application Number _____
filed _____
and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

Priority Claimed

2001-240741 Japan 08/08/2001 X Yes ___ No
(Number) (Country) (Day/Month/Year Filed)

2001-240746 Japan 08/08/2001 X Yes No
(Number) (Country) (Day/Month/Year Filed)

2001-259840 Japan 29/08/2001 X Yes ___ No
(Number) (Country) (Day/Month/Year Filed)

<u>(Appln. Serial No.)</u>	<u>(Filing Date)</u>	<u>(Status-patented, pending, abandoned)</u>
<u>(Appln. Serial No.)</u>	<u>(Filing Date)</u>	<u>(Status-patented, pending, abandoned)</u>

Please address all correspondence and telephone calls to:

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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